

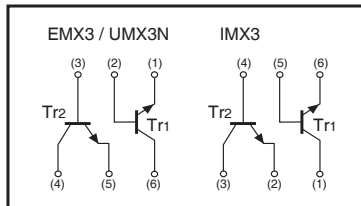
General purpose (dual transistors)

EMX3 / UMX3N / IMX3

●Features

Two 2SC2412AK chips in a EMT or UMT or SMT package.

●Inner circuits



●Package, marking, and packaging specifications

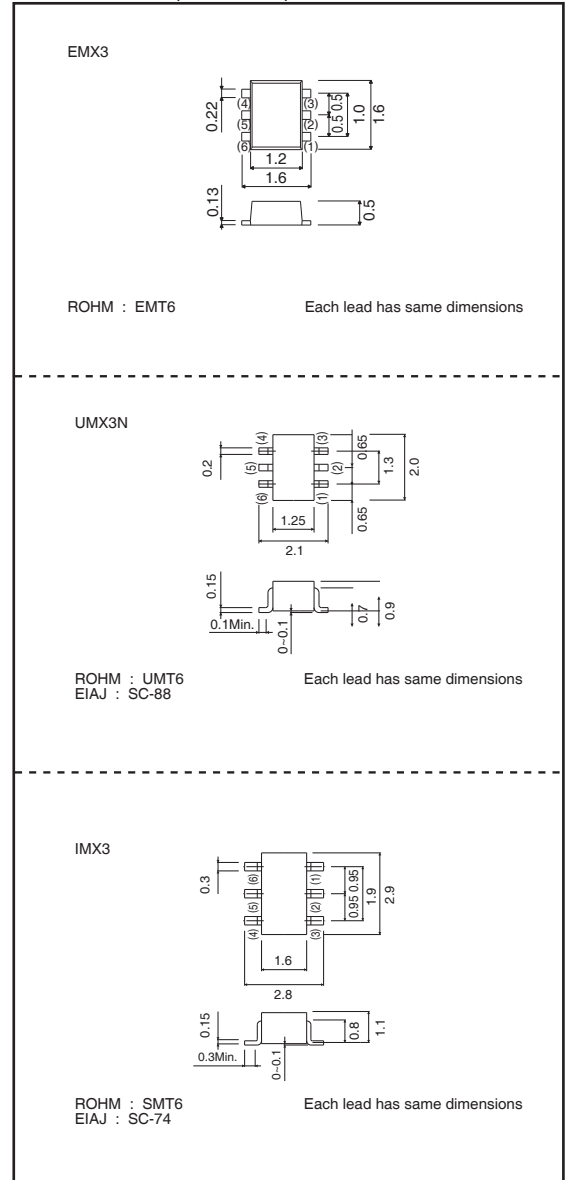
Type	EMX3	UMX3N	IMX3
Package	EMT6	UMT6	SMT6
Marking	X3	X3	X3
Code	T2R	TR	T108
Basic ordering unit (pieces)	8000	3000	3000

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V_{CBO}	60	V
Collector-emitter voltage	V_{CEO}	50	V
Emitter-base voltage	V_{EBO}	7	V
Collector current	I_C	150	mA
Collector power dissipation	EEMX3 / UMX3N	150(TOTAL)	mW ^{*1}
	IMX3	300(TOTAL)	mW ^{*2}
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

^{*1} 120mW per element must not be exceeded.
^{*2} 200mW per element must not be exceeded.

●Dimensions (Unit : mm)



●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	60	-	-	V	$I_C=50\mu A$
Collector-emitter breakdown voltage	BV_{CEO}	50	-	-	V	$I_C=1mA$
Emitter-base breakdown voltage	BV_{EBO}	7	-	-	V	$I_E=50\mu A$
Collector cutoff current	I_{CBO}	-	-	0.1	μA	$V_{CB}=60V$
Emitter cutoff current	I_{EBO}	-	-	0.1	μA	$V_{EB}=7V$
Collector-emitter saturation voltage	$V_{CE(sat)}$	-	-	0.4	V	$I_C/I_E=50mA/5mA$
DC current transfer ratio	h_{FE}	120	-	560	-	$V_{CE}=6V, I_C=1mA$
Transition frequency	f_T	-	180	-	MHz	$V_{CE}=12V, I_E=-2mA, f=100MHz$ *
Output capacitance	C_{ob}	-	2	3.5	pF	$V_{CB}=12V, I_E=0mA, f=1MHz$

*Transition frequency of the device.

●Electrical characteristics curves

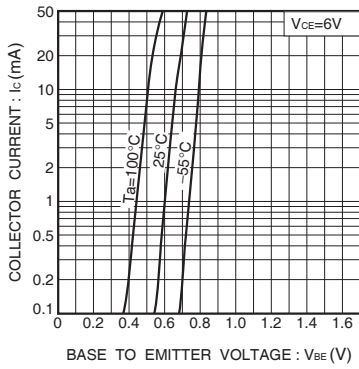


Fig.1 Grounded emitter propagation characteristics

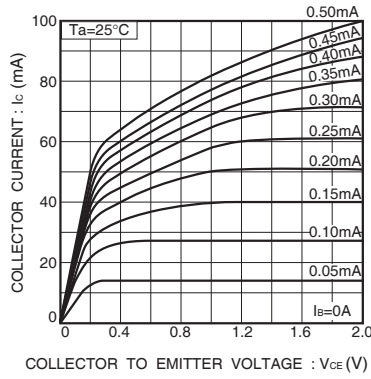


Fig.2 Grounded emitter output characteristics (I)

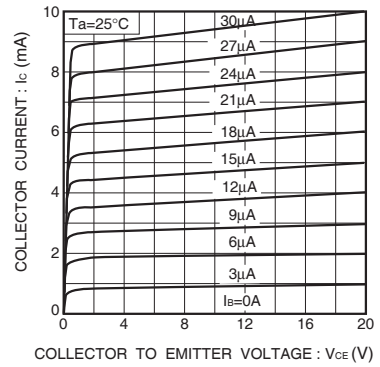


Fig.3 Grounded emitter output characteristics (II)

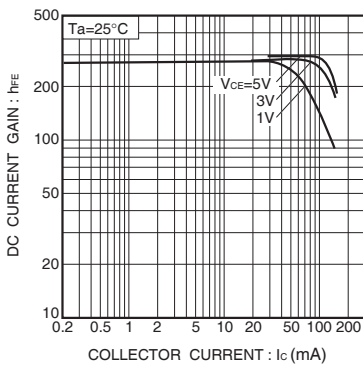


Fig.4 DC current gain vs. collector current (I)

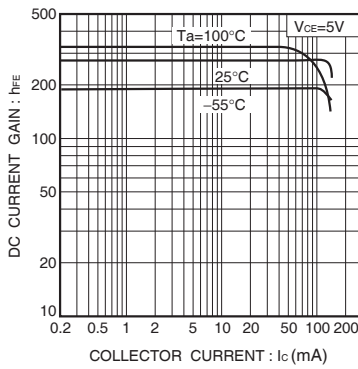


Fig.5 DC current gain vs. collector current (II)

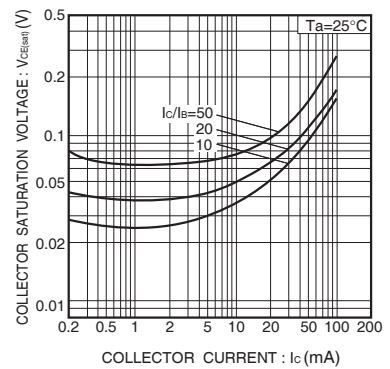


Fig.6 Collector-emitter saturation voltage vs. collector current

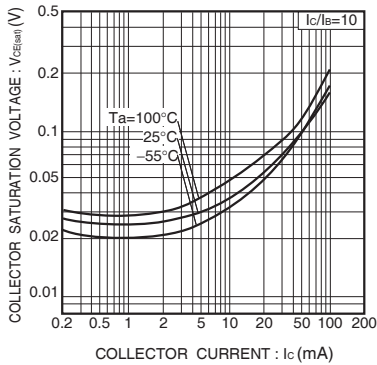


Fig.7 Collector-emitter saturation voltage vs. collector current (I)

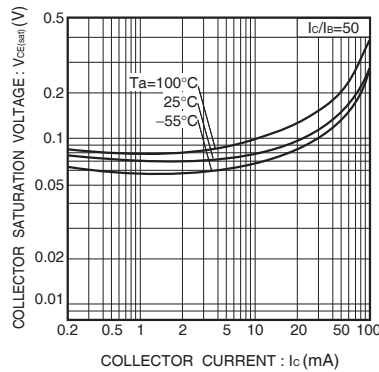


Fig.8 Collector-emitter saturation voltage vs. collector current (II)

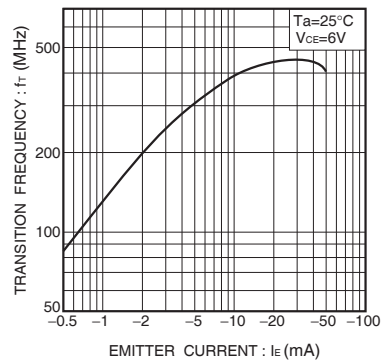


Fig.9 Gain bandwidth product vs. emitter current

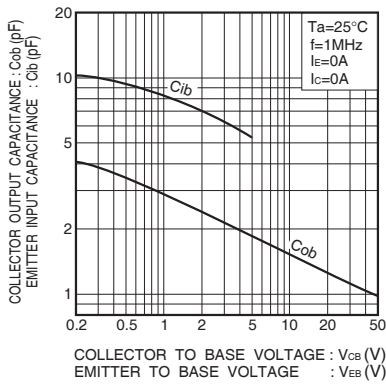


Fig.10 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage

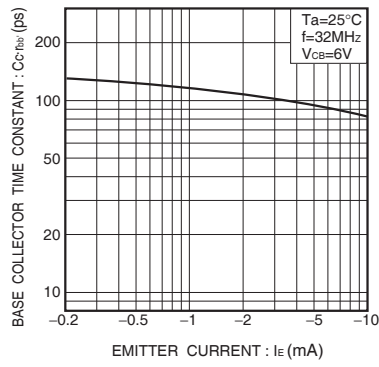


Fig.11 Base-collector time constant vs. emitter current

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

<http://www.rohm.com/contact/>